



# Chip Termination 250 Watts, $50\Omega$

## **Description:**

The A250N50X4 is high performance Aluminum Nitride (AIN) chip termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators and for use in power combiners. The termination is also RoHS compliant!

#### Features:

- RoHS Compliant
- 450 Watts
- DC 1.7GHz
- AIN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

### **General Specifications:**

Resistive Element Thick Film
Substrate AIN Ceramic

**Terminal Finish** Matte Tin over Nickel Barrier **Operating Temperature** -50 to +200°C (see de rating chart)

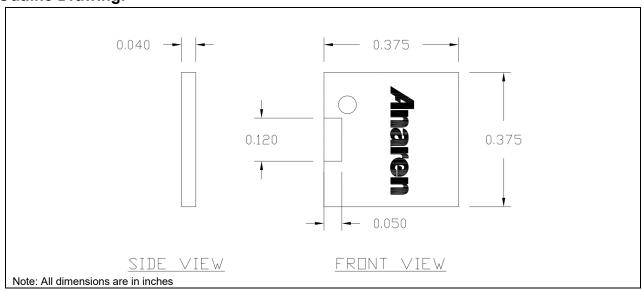
#### **Electrical Specifications:**

Resistance Value:50 Ohms, ± 2%Power:250 WattsFrequency Range:DC - 2.2 GHz

Return Loss > 20 dB DC – 2.2 GHz

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. Specifications subject to change.

### **Outline Drawing:**

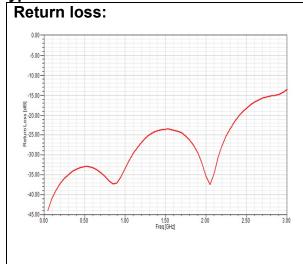


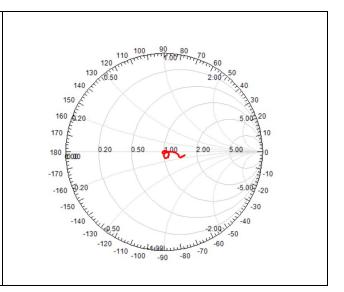
Tolerance is ±0.010", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.



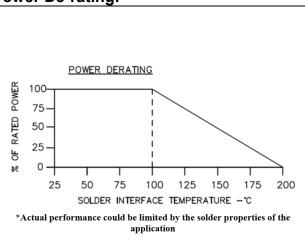


**Typical Performance:** 

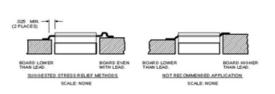




**Power De-rating:** 



**Mounting Footprint:** 



#### SUGGESTED MOUNTING PROCEDURE

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING AN APPROPRIATE SOLDER.
- SOLDER LEADS IN PLACE USING AN APPROPRIATE SOLDER TYPE WITH A CONTROLLED TEMPERATURE IRON.

Contact us: rf&s\_support@ttm.com